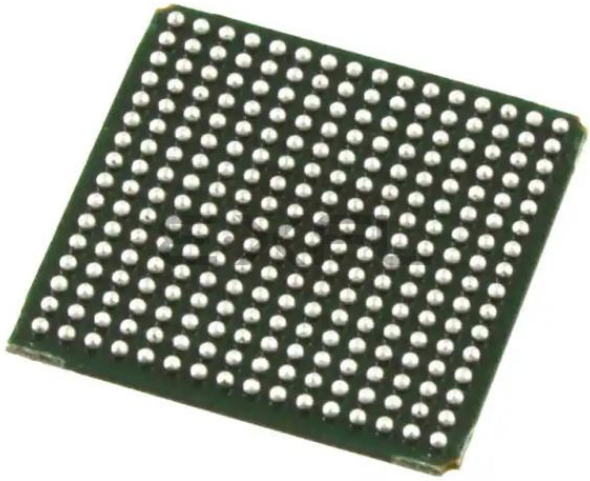
Lattice Semiconductor Corporation - LFX200EB-04FN256C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	2704
Total RAM Bits	113664
Number of I/O	160
Number of Gates	210000
Voltage - Supply	2.3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfx200eb-04fn256c

Product Line	Ordering Part Number	Product Status	Reference PCN
LFX500EC (Cont'd)	LFX500EC-03F900C	**Discontinued**	PCN#09-10
	LFX500EC-03FN900C		
	LFX500EC-04F900C		
	LFX500EC-04FN900C		
	LFX500EC-03F900I		
	LFX500EC-03FN900I		
LFX1200EB	LFX1200EB-03FE680C	**Discontinued**	PCN#03A-10
	LFX1200EB-04FE680C		
	LFX1200EB-05FE680C		
	LFX1200EB-03FE680I		
	LFX1200EB-04FE680I		
	LFX1200EB-03F900C		
	LFX1200EB-04F900C		
	LFX1200EB-05F900C		
	LFX1200EB-03F900I		
	LFX1200EB-04F900I		
LFX1200EC	LFX1200EC-03FE680C	**Discontinued**	PCN#03A-10
	LFX1200EC-04FE680C		
	LFX1200EC-03FE680I		
	LFX1200EC-03F900C		
	LFX1200EC-04F900C		
	LFX1200EC-03F900I		

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Internet: http://www.latticesemi.com

ispXPGA® Family

Includes High-Performance, Low-Cost "E-Series"

February 2010

Data Sheet DS1026

- **Non-volatile, Infinitely Reconfigurable**
  - Instant-on - Powers up in microseconds via on-chip E²CMOS® based memory
  - No external configuration memory
  - Excellent design security, no bit stream to intercept
  - Reconfigure SRAM based logic in milliseconds
- **High Logic Density for System-level Integration**
  - 139K to 1.25M functional gates
  - 160 to 496 I/O
  - 1.8V, 2.5V, and 3.3V V_{CC} operation
  - Up to 414Kb sysMEM™ embedded memory
- **High Performance Programmable Function Unit (PFU)**
  - Four LUT-4 per PFU supports wide and narrow functions
  - Dual flip-flops per LUT-4 for extensive pipelining
  - Dedicated logic for adders, multipliers, multiplexers, and counters
- **Flexible Memory Resources**
  - Multiple sysMEM Embedded RAM Blocks
    - Single port, Dual port, and FIFO operation
  - 64-bit distributed memory in each PFU
    - Single port, Double port, FIFO, and Shift Register operation
- **Flexible Programming, Reconfiguration, and Testing**
  - Supports IEEE 1532 and 1149.1
  - Microprocessor configuration interface
  - Program E²CMOS while operating from SRAM
- **Eight sysCLOCK™ Phase Locked Loops (PLLs) for Clock Management**
  - True PLL technology
  - 10MHz to 320MHz operation
  - Clock multiplication and division
  - Phase adjustment
  - Shift clocks in 250ps steps
- **sysIO™ for High System Performance**
  - High speed memory support through SSTL and HSTL
  - Advanced buses supported through PCI, GTL+, LVDS, BLVDS, and LVPECL
  - Standard logic supported through LVTTL, LVCMOS 3.3, 2.5 and 1.8
  - 5V tolerant I/O for LVCMOS 3.3 and LVTTL interfaces
  - Programmable drive strength for series termination
  - Programmable bus maintenance
- **Two Options Available**
  - High-performance sysHSI (standard part number)
  - Low-cost, no sysHSI ("E-Series")
- **sysHSI™ Capability for Ultra Fast Serial Communications**
  - Up to 800Mbps performance
  - Up to 20 channels per device
  - Built in Clock Data Recovery (CDR) and Serialization and De-serialization (SERDES)

Table 1. ispXPGA Family Selection Guide

	ispXPGA 125/E	ispXPGA 200/E	ispXPGA 500/E	ispXPGA 1200/E[3]
Functional Gates	139K	210K	476K	1.25M
PFUs	484	676	1764	3844
LUT-4s	1936	2704	7056	15376
Logic FFs	3.8K	5.4K	14.1K	30.7K
sysMEM Memory	92K	111K	184K	414K
Distributed Memory	30K	43K	112K	246K
EBR	20	24	40	90
sysHSI Channels[1]	4	8	12	20
User I/O	160/176	160/208	336	496
Packaging	256 fpBGA 516 fpBGA[2]	256 fpBGA 516 fpBGA[2]	516 fpBGA[2] 900 fpBGA	680 fpSBGA 900 fpBGA

1. "E-Series" does not support sysHSI.
2. FH516 package was converted to F516 via PCN #09A-08.
3. Discontinued via PCN #03A-10.

Set/Reset signal controls all the registers for each PFU. This common Set/Reset signal is composed of the logical OR term of the Global Set/Reset signal (GSR) and the selected signal from routing. The polarity of this signal is not controllable inside the PFU. The polarity of the Global Set/Reset signal (GSR) is programmable. Figure 9 shows the Clock Enable and Output Enable selection for each PFU.

Figure 7. Clock Selection per PFU

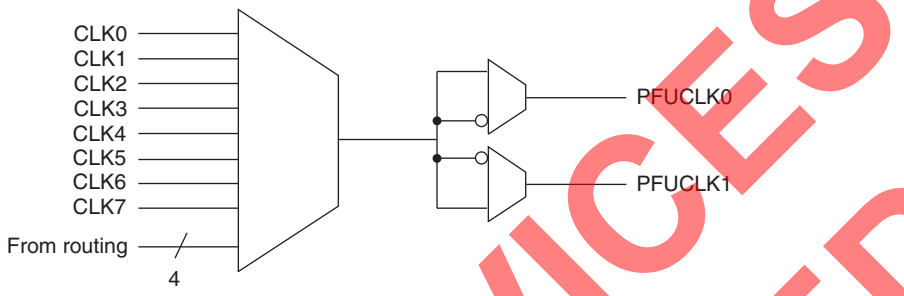


Figure 8. Set/Reset Selection per PFU

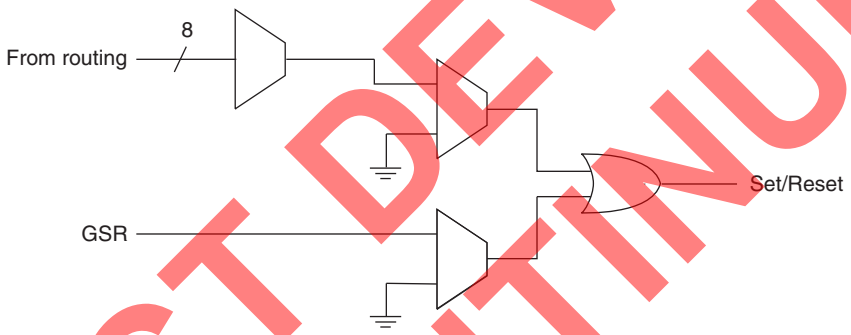
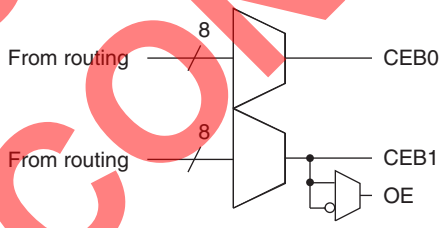


Figure 9. Clock Enable and Output Enable Selection per PFU

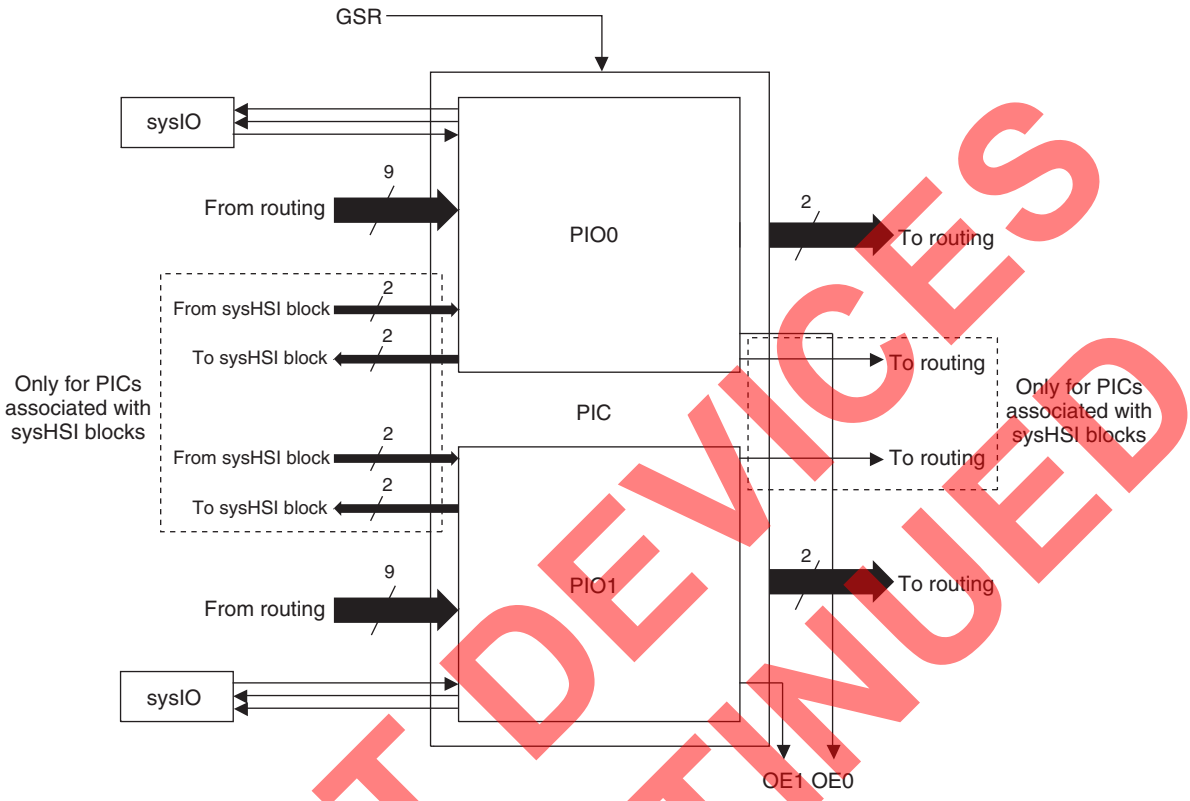


Programmable Input/Output Cell

The Programmable Input/Output Cell (PIC) is an essential part of the symmetrical architecture of the ispXPGA Family. The PICs interface the PFUs and EBRs to the sysIO and sysHSI blocks of the device.

Each PIC contains two Programmable Input/Outputs (PIOs) with a total of 21 inputs and 10 outputs. There are 18 inputs from routing, two inputs from the sysIO buffers, and the Global Set/Reset signal. Four outputs of the PIC connect to routing and two outputs are available as Output Enables for the tri-statable Long Lines. The remaining four outputs feed the sysIO buffers directly (one output enable and one output to each). Each PIC associated with a sysHSI block has four additional inputs and six additional outputs to support the sysHSI blocks. The four additional inputs come from the sysHSI block associated with the PIC. The four of the six additional outputs come from the PIC outputs and feed the sysHSI block, while the remaining two outputs feed routing. Figure 10 shows the block diagram of the PIC with the sysHSI block inputs and outputs.

Figure 10. ispXPGA PIC



Programmable Input/Output

The PIO is the building block of a PIC. The PIO has a total of 11 inputs and five outputs. Nine of the 11 inputs are generated from routing. The inputs from routing are the PIO Input (IN), Feed-Thru (FT), Clock (CLK), Input Clock Enable (ICE), Input Set/Reset (ISR), Output Clock Enable (OCEN), Output Set/Reset (OSR), PIO Output Enable (OEN), and PIO Input Enable (IEN). The remaining inputs are the sysIO input buffer signal and the Global Set/Reset signal. Three of the five outputs (OUT0, OUT1, and OE) feed routing. The last two outputs feed the sysIO buffer directly as the output and output enable of the sysIO output buffer.

PIOs associated with sysHSI blocks contain two additional inputs and outputs to support the sysHSI block. The two inputs come from the sysHSI block associated with the PIO, and the two outputs feed the sysHSI block. One of the inputs routes directly through the PIO to routing, while the other is multiplexed with the Feed-Thru, register bypass, and Q output of the register to form the OUT1 output of the PIO. The outputs to the sysHSI block are the same signals as the outputs which feed the sysIO buffers (sysIO Output and sysIO Output Enable).

Each PIO has an input register, an output register, and an output enable register as shown in Figure 11. The input register path of the PIO has a 'delay' option, which slows the data-flow. A two-input OR function of the Global Set/Reset (GSR) and Set/Reset (ISR or OSR) signals creates the set/reset term for the respective registers. Each PIO has two pairs of set/reset and clock enable signals. One is exclusive to the input register, whereas the other is common for both the output and output enable registers. The clock (CLK) is common to all registers in a PIO, and the polarity of the clock is controllable. The input, output, and the output enable registers can be configured as a latch or D-type flip-flop. Each PIO is capable of generating an output enable signal, which in turn becomes a PIC output.

The second type of interface implemented is the terminated, single-ended interface standard. This group of interfaces includes different versions of SSTL and HSTL interfaces along with CTT, and GTL+. Usage of these particular I/O interfaces requires an additional V_{REF} signal. At the system level a termination voltage, V_{TT}, is also required. Typically an output will be terminated to V_{TT} at the receiving end of the transmission line it is driving.

The third type of interface standards are the differential standards LVDS, BLVDS, and LVPECL. The differential standards require two I/O pins to create the differential pair. The logic level is determined by the difference in the two signals. Table 6 lists how these interface standards are implemented in the ispXPGA devices.

For more information on sysIO capability, refer to TN1000, sysIO Usage Guidelines for Lattice Devices.

Figure 19. sysIO Banks per Device

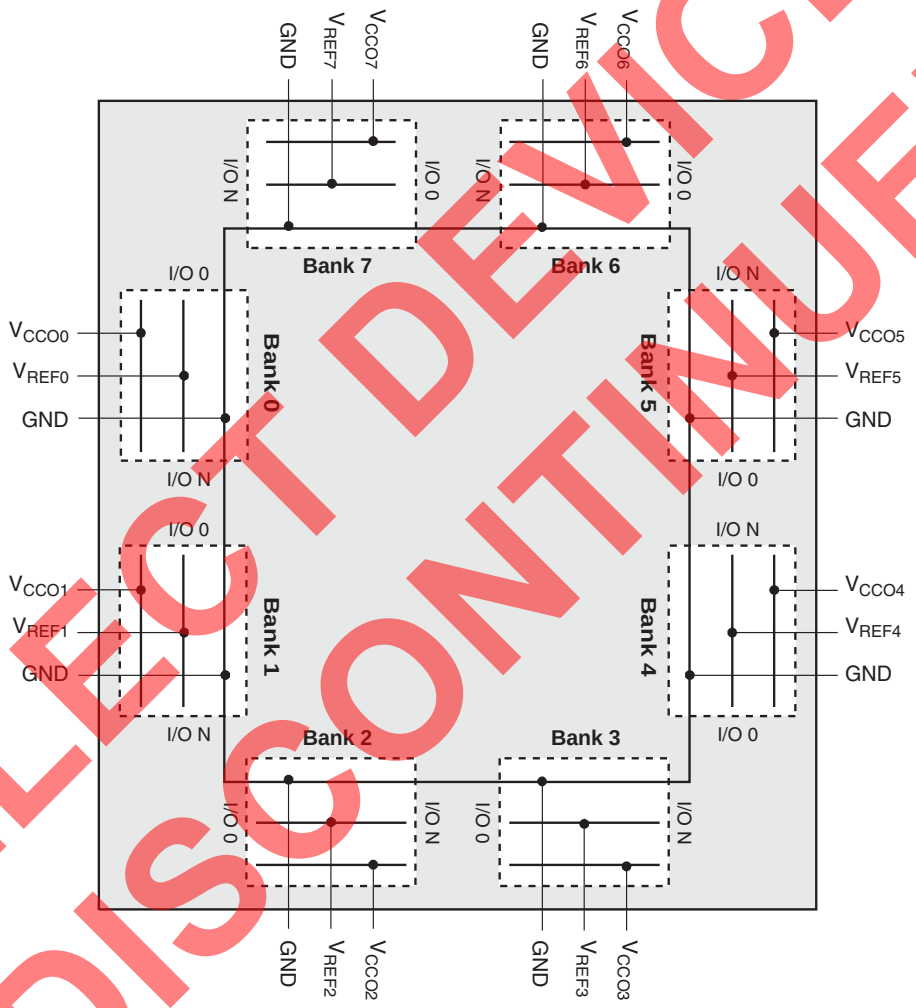


Table 4. Number of I/Os per Bank

Device	Max. Number of I/Os per Bank (N)
XPGA 1200	62
XPGA 500	42
XPGA 200	26
XPGA 125	22

sysIO Differential Standards DC Electrical Characteristics[1]

Parameter	Description	Test Conditions	Min.	Typ.	Max.
LVDS[2]					
V_{INP}, V_{INM}	Input voltage		0V	—	2.4V
V_{THD}	Differential input threshold	0.2V ð V_{CM} ð 1.8V	+/-100mV	—	—
I_{IN}	Input current	Power on	—	—	+/-10uA
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	RT = 100 Ohm	—	1.38V	1.60V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	RT = 100 Ohm	0.9V	1.03V	—
V_{OD}	Output Voltage Differential	$\|V_{OP} - V_{OM}\|$, R_T = 100 ohm	250mV	350mV	450mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50mV
V_{OS}	Output Voltage Offset	$\|V_{OP} + V_{OM}\|/2$, R_T = 100 ohm	1.125V	1.25V	1.375V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50mV
I_{OSD}	Output short circuit current	V_{OD} = 0V Driver outputs shorted	—	—	24mA
BLVDS[1]					
V_{INP}, V_{INM}	Input voltage		0V	—	2.4V
V_{THD}	Differential input threshold	0.2V ð V_{CM} ð 1.8V	+/-100mV	—	—
I_{IN}	Input current	Power on	—	—	+/-10uA
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	R_T = 27Ω	—	1.4V	1.80V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	R_T = 27Ω	0.95V	1.1V	—
V_{OD}	Output Voltage Differential	$\|V_{OP} - V_{OM}\|$, RT = 27Ω	240mV	300mV	460mV
ΔV_{OD}	Change in V_{OD} Between H and L				27mV
V_{OS}	Output Voltage Offset	$\|V_{OP} + V_{OM}\|$ /2, RT = 27Ω	1.1V	1.3V	1.5V
ΔV_{OS}	Change in V_{OS} Between H and L				27mV
I_{OSD}	Output Short Circuit Current	V_{OD} = 0. Driver Outputs Shorted.		36mA	65mA

1. Refer to TN1000, sysIO Usage Guidelines for Lattice Devices.
2. V_{OP} and V_{OM} are the two outputs of the LVDS/BLVDS output buffer.

LVPECL[1]								
DC Parameter	**Parameter Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
V_{CCO}		**3.0**		**3.3**		**3.6**		**V**
V_{IH}	Input Voltage High	1.49	2.72	1.49	2.72	1.49	2.72	V
V_{IL}	Input Voltage Low	0.86	2.125	0.86	2.125	0.86	2.125	V
V_{OH}	Output Voltage High	1.8	2.11	1.92	2.28	2.13	2.41	V
V_{OL}	Output Voltage Low	0.96	1.27	1.06	1.43	1.3	1.57	V
V_{DIFF}[2]	Differential Input threshold	0.3	—	0.3	—	0.3	—	V

1. These values are valid at the output of the source termination pack as shown above with 100-ohm differential load only (see Figure 23). The V_{OH} levels are 200mV below the standard LVPECL levels and are compatible with devices tolerant of the lower common mode ranges.
2. Valid for 0.2 ð V_{CM} ð 1.8V.

ispXPGA 125B/C & ispXPGA 125EB/EC PFU Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Reset/Set								
t_{LASSRO}	Asynchronous Set/Reset to Output	—	1.09	—	1.17	—	1.35	ns
$t_{LASSRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{LASSRR}	Asynchronous Set/Reset Recovery	—	0.51	—	0.55	—	0.63	ns
t_{LSSR_S}	Synchronous Set/Reset Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{LSSR_H}	Synchronous Set/Reset Hold Time	0.03	—	0.03	—	0.03	—	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.
2. $t_{LCTHRUL}$ quoted bit by bit.

Timing v.0.3

ispXPGA 125B/C & ispXPGA 125EB/EC PIC Timing Parameters

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Register/Latch Delays								
t_{IO_CO}	Register Clock to Output Delay	—	0.89	—	0.96	—	1.10	ns
t_{IO_S}	Register Setup Time (Data before Clock)	0.05	—	0.05	—	0.06	—	ns
t_{IO_H}	Register Hold Time (Data after Clock)	0.06	—	0.06	—	0.07	—	ns
t_{IOCE_S}	Register Clock Enable Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{IOCE_H}	Register Clock Enable Hold Time	0.13	—	0.13	—	0.15	—	ns
t_{IO_GO}	Latch Gate to Output Delay	—	0.68	—	0.73	—	0.84	ns
t_{IOL_S}	Latch Setup Time	0.05	—	0.05	—	0.06	—	ns
t_{IOL_H}	Latch Hold Time	0.06	—	0.06	—	0.07	—	ns
t_{IOLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns
t_{IOASRO}	Asynchronous Set/Reset to Output	—	1.00	—	1.08	—	1.24	ns
$t_{IOASRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{IOASRR}	Asynchronous Set/Reset Recovery Time	—	0.23	—	0.25	—	0.29	ns
Input/Output Delays								
t_{IOBUF}	Output Buffer Delay	—	0.97	—	1.04	—	1.20	ns
t_{IOIN}	Input Buffer Delay	—	0.57	—	0.61	—	0.70	ns
t_{IOEN}	Output Enable Delay	—	0.53	—	0.57	—	0.66	ns
t_{IODIS}	Output Disable Delay	—	-0.14	—	-0.13	—	-0.11	ns
t_{IOFT}	Feed-thru Delay	—	0.19	—	0.20	—	0.23	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 125B/C & ispXPGA 125EB/EC Timing Adders

Parameter	Description	Base Parameter	-5[1]		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
$t_{IOINDLY}$	Input Delay	—	—	4.28	—	4.6	—	5.29	ns
t_{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_18_in	Using 1.8V CMOS	t_{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_in	Using 2.5V CMOS	t_{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVCMOS_33_in	Using 3.3V CMOS	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t_{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t_{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t_{IOIN}	—	0.8	—	0.8	—	0.8	ns
t_{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVCMOS Outputs only)	t_{IOBUF}, t_{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVCMOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVCMOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVCMOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVCMOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVCMOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVCMOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t_{IOBUF}, t_{IOEN}, t_{IODIS}	—	0.5	—	0.5	—	0.5	ns

ispXPGA 500B/C & ispXPGA 500EB/EC PFU Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Functional Delays								
LUTs								
t_{LUT4}	4-Input LUT Delay	—	0.41	—	0.44	—	0.51	ns
t_{LUT5}	5-Input LUT Delay	—	0.73	—	0.79	—	0.91	ns
t_{LUT6}	6-Input LUT Delay	—	0.86	—	0.93	—	1.07	ns
Shift Register (LUT)								
t_{LSR_S}	Shift Register Setup Time	-0.64	—	-0.62	—	-0.53	—	ns
t_{LSR_H}	Shift Register Hold Time	0.61	—	0.63	—	0.72	—	ns
t_{LSR_CO}	Shift Register Clock to Output Delay	—	0.70	—	0.75	—	0.86	ns
Arithmetic Functions								
$t_{LCTHRUR}$	MC (Macro Cell) Carry In to MC Carry Out Delay (Ripple)	—	0.08	—	0.09	—	0.10	ns
$t_{LCTHRUL}$[2]	MC Carry In to MC Carry Out Delay (Look Ahead)	—	0.05	—	0.05	—	0.06	ns
t_{LSTHRU}	MC Sum In to MC Sum Out Delay	—	0.42	—	0.45	—	0.52	ns
$t_{LSINCOUT}$	MC Sum In to MC Carry Out Delay	—	0.29	—	0.31	—	0.36	ns
$t_{LCINSOUTR}$	MC Carry In to MC Sum Out Delay (Ripple)	—	0.36	—	0.39	—	0.45	ns
$t_{LCINSOUTL}$	MC Carry In to MC Sum Out Delay (Look Ahead)	—	0.26	—	0.28	—	0.32	ns
Feed-thru								
t_{LFT}	PFU Feed-Thru Delay	—	0.15	—	0.16	—	0.18	ns
Distributed RAM								
t_{LRAM_CO}	Clock to RAM Output	—	1.24	—	1.33	—	1.53	ns
t_{LRAMAD_S}	Address Setup Time	-0.41	—	-0.40	—	-0.34	—	ns
t_{LRAMD_S}	Data Setup Time	0.21	—	0.22	—	0.25	—	ns
t_{LRAMWE_S}	Write Enable Setup Time	0.45	—	0.46	—	0.53	—	ns
t_{LRAMAD_H}	Address Hold Time	0.58	—	0.60	—	0.69	—	ns
t_{LRAMD_H}	Data Hold Time	0.11	—	0.11	—	0.13	—	ns
t_{LRAMWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{LRAMCPW}$	Clock Pulse Width (High or Low)	2.91	—	3.00	—	3.45	—	ns
$t_{LRAMADO}$	Address to Output Delay	—	0.86	—	0.93	—	1.07	ns
Register/Latch Delays								
Registers								
t_{L_CO}	Register Clock to Output Delay	—	0.58	—	0.62	—	0.71	ns
t_{L_S}	Register Setup Time (Data before Clock)	0.14	—	0.14	—	0.16	—	ns
t_{L_H}	Register Hold Time (Data after Clock)	-0.12	—	-0.12	—	-0.10	—	ns
t_{LCE_S}	Register Clock Enable Setup Time	-0.11	—	-0.11	—	-0.09	—	ns
t_{LCE_H}	Register Clock Enable Hold Time	0.11	—	0.11	—	0.13	—	ns
Latches								
t_{L_GO}	Latch Gate to Output Delay	—	0.09	—	0.10	—	0.12	ns
t_{LL_S}	Latch Setup Time	0.14	—	0.14	—	0.16	—	ns
t_{LL_H}	Latch Hold Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{LLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns

ispXPGA 1200B/C & ispXPGA 1200EB/EC EBR Timing Parameters

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Synchronous Write								
t_{EBSWAD_S}	Address Setup Delay	0.59	—	0.61	—	0.70	—	ns
t_{EBSWAD_H}	Address Hold Delay	-0.40	—	-0.39	—	-0.33	—	ns
$t_{EBSWCPW}$	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t_{EBSWWE_S}	Write Enable Setup Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{EBSWWE_H}	Write Enable Hold Time	0.16	—	0.16	—	0.18	—	ns
t_{EBSWD_S}	Data Setup Time	0.27	—	0.28	—	0.32	—	ns
t_{EBSWD_H}	Data Hold Time	-0.27	—	-0.26	—	-0.22	—	ns
Synchronous Read								
t_{EBSR_CO}	Clock to Data Delay	—	2.04	—	2.19	—	2.52	ns
t_{EBSRAD_S}	Address Setup Delay	0.10	—	0.10	—	0.12	—	ns
t_{EBSRAD_H}	Address Hold Delay	-0.07	—	-0.07	—	-0.06	—	ns
$t_{EBSRCPW}$	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t_{EBSRCE_S}	Clock Enable Setup Time	-1.76	—	-1.71	—	-1.45	—	ns
t_{EBSRCE_H}	Clock Enable Hold Time	1.64	—	1.69	—	1.94	—	ns
t_{EBSRWE_S}	Write Enable Setup Time	-0.18	—	-0.17	—	-0.14	—	ns
t_{EBSRWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{EBSRWEEN}$	Write Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
$t_{EBSRWEDIS}$	Write Enable to Data Disable Time	—	0.99	—	1.02	—	1.17	ns
t_{EBSREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
$t_{EBSRDIS}$	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns
Asynchronous Read								
$t_{EBARADO}$	Address to New Valid Data Delay	—	2.39	—	2.46	—	2.83	ns
t_{EBARAD_H}	Address to Previous Valid Data Delay	—	2.10	—	2.17	—	2.50	ns
$t_{EBARWEEN}$	Write Enable to Data Enable Time	—	1.01	—	1.04	—	1.20	ns
$t_{EBARWEDIS}$	Write Enable to Data Disable Time	—	0.98	—	1.01	—	1.16	ns
t_{EBAREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
$t_{EBARDIS}$	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns

1. Only available for ispXPGA 1200B and ispXPGA 1200EB (2.5V/3.3V) devices.

Timing v.2.1

ispXP sysCONFIG Port Timing Specifications

Symbol	Timing Parameter	Min.	Typ.	Max.	Units
sysCONFIG Write Cycle Timing					
t_{SUCS}	Input setup time of CS to CCLK rise	10	—	—	ns
t_{HCS}	Hold time of CS to CCLK Rise	0	—	—	ns
t_{SUWD}	Input setup time of write data to CCLK rise	12	—	—	ns
t_{HWD}	Hold time of write data to CCLK rise	0	—	—	ns
t_{PRGM}	Low time to reset device SRAM	5	—	50	ns
t_{WINIT}	INIT pulse width	—	—	5	ms
t_{IODISS}	User I/O disable	—	—	30	ns
t_{IOENSS}	User I/O enable	—	—	30	ns
t_{WH}	Write clock High pulse width	12	—	—	ns
t_{WL}	Write clock Low pulse width	12	—	—	ns
f_{MAXW}	Write f_{MAX}	—	—	33	MHz
sysCONFIG Read Cycle Timing					
t_{HREAD}	Hold time of READ to CCLK rise	0	—	—	ns
t_{SUREAD}	Input setup time of READ High to CCLK rise	30	—	—	ns
t_{RH}	READ clock high pulse width	12	—	—	ns
t_{RL}	READ clock low pulse width	15	—	—	ns
f_{MAXR}	Read f_{MAX}	—	—	33	MHz
t_{CORD}	Clock to out for read data	—	—	25	ns

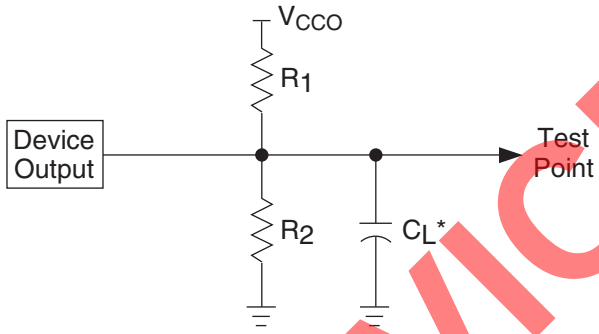
Boundary Scan Timing

Parameter	Description	Min.	Max.	Units
t_{BTCP}	TCK [BSCAN] Clock Pulse Width	40	—	ns
t_{BTCPH}	TCK [BSCAN] Clock Pulse Width High	20	—	ns
t_{BTCPL}	TCK [BSCAN] Clock Pulse Width Low	20	—	ns
t_{BTS}	TCK [BSCAN] Setup Time	8	—	ns
t_{BTH}	TCK [BSCAN] Hold Time	10	—	ns
t_{BTRF}	TCK [BSCAN] Rise/Fall Time	50	—	mV/ns
t_{BTCO}	TAP Controller Falling Edge of Clock to Valid Output	—	18	ns
$t_{BTCODIS}$	TAP Controller Falling Edge of Clock to Valid Disable	—	18	ns
t_{BTCOEN}	TAP Controller Falling Edge of Clock to Valid Enable	—	18	ns
t_{BTCRS}	BSCAN Test Capture Register Setup Time	8	—	ns
t_{BTCRH}	BSCAN Test Capture Register Hold Time	25	—	ns
t_{BUTCO}	BSCAN Test Update Register, Falling Edge of Clock to Valid Output	—	45	ns
$t_{BTUODIS}$	BSCAN Test Update Register, Falling Edge of Clock to Valid Disable	—	20	ns
$t_{BTUPOEN}$	BSCAN Test Update Register, Falling Edge of Clock to Valid Enable	—	20	ns

Switching Test Conditions

Figure 25 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 7.

Figure 25. Output Test Load, LVTTL and LVCMOS Standards



*C_L includes test fixture and probe capacitance.

Table 7. Text Fixture Required Components

Test Condition	R_1	R_2	C_L	Timing Reference	VCCO
LVCMOS I/O, (L -> H, H -> L)	106	106	35pF	LVCMOS 3.3 = V_{CCO}/2	LVCMOS 3.3 = 3.0V
				LVCMOS 2.5 = V_{CCO}/2	LVCMOS 2.5 = 2.3V
				LVCMOS 1.8 = V_{CCO}/2	LVCMOS 1.8 = 1.65V
Default LVCMOS 1.8 I/O (Z -> H)	×	106	35pF	0.9V	1.65V
Default LVCMOS 1.8 I/O (Z -> L)	106	×	35pF	0.9V	1.65V
Default LVCMOS 1.8 I/O (H -> Z)	×	106	5pF	V_{OH} - 0.3	1.65V
Default LVCMOS 1.8 I/O (L -> Z)	106	×	5pF	V_{OL} + 0.3	1.65V

Note: Output test conditions for all other interfaces are determined by the respective standards.

ispXPGA Power Supply and NC Connections[1] (Continued)

Signal	680-Ball fpBGA[3]	900-Ball fpBGA[3]
NC[2]	A3, B29, AW3, AV3, AW11, AV11, AV29, AW29, AW37, B3, AV37, C39, C38, AU39, AU38, AJ39, AJ38, N38, N39, C2, C1, AU1, AU2, AJ2, AJ1, N2, N1, B11, A11, A37, B37, A29	**LFX500:** A8, A9, A10, A11, A19, A20, A21, A22, B8, B9, B10, B11, B19, B20, B21, B22, C1, C2, C11, C12, C19, C20, C23, D3, D10, D11, D12, D19, D20, D21, D22, D23, E3, E5, E6, E10, E11, E12, E21, E22, E25, E26, E28, E29, E30, F1, F2, F6, F9, F10, F11, F12, F21, F22, F25, F26, F29, F30, G1, G2, G3, G4, G7, G8, G9, G10, G11, G12, G14, G15, G16, G17, G19, G20, G21, G22, G23, G24, G25, G26, G27, G28, G29, G30, H1, H2, H3, H4, H5, H6, H7, H8, H9, H10, H11, H12, H13, H14, H15, H16, H17, H18, H19, H20, H21, H22, H23, H24, H27, H28, H29, H30, J1, J2, J4, J5, J6, J7, J8, J9, J10, J11, J12, J13, J14, J15, J16, J17, J18, J19, J20, J21, J22, J23, J24, J25, J26, J27, K6, K7, K8, K9, K10, K12, K13, K14, K15, K16, K17, K18, K19, K21, K22, K23, K24, K25, L7, L8, L9, L22, L23, L24, M7, M8, M9, M10, M21, M22, M23, M24, N8, N9, N10, N21, N22, N23, P7, P8, P9, P10, P21, P22, P23, P24, R8, R9, R10, R21, R22, R23, R24, R25, T6, T7, T8, T9, T10, T21, T22, T23, T24, T25, U7, U8, U9, U10, U21, U22, U23, U24, V8, V9, V10, V21, V22, V23, W7, W8, W9, W10, W21, W22, W23, W24, W25, W26, Y3, Y4, Y5, Y6, Y7, Y8, Y9, Y22, Y23, Y24, Y25, Y26, Y27, Y28, AA4, AA5, AA6, AA7, AA8, AA9, AA10, AA12, AA13, AA14, AA15, AA16, AA17, AA18, AA19, AA21, AA22, AA23, AA24, AA25, AA26, AA27, AB1, AB2, AB4, AB5, AB6, AB7, AB8, AB9, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AB18, AB19, AB20, AB21, AB22, AB23, AB24, AB25, AB26, AB27, AC1, AC2, AC3, AC4, AC5, AC6, AC7, AC8, AC9, AC10, AC11, AC12, AC13, AC14, AC15, AC16, AC17' AC18' AC19, AC20, AC21, AC22, AC23, AC24, AC27, AC28, AC29, AC30, AD1, AD2, AD7, AD8, AD9, AD10, AD11, AD12, AD14, AD15, AD16, AD17, AD19, AD20, AD21, AD22, AD23, AD24, AD29, AD30, AE6, AE9, AE10, AE11, AE12, AE19, AE20, AE21, AE22, AE25, AE29, AE30, AF5, AF6, AF10, AF11, AF12, AF19, AF20, AF21, AF22, AF25, AF26, AG10, AG11, AG12, AG19, AG20, AG21, AG22, AH11, AH12, AH19, AH20, AJ8, AJ9, AJ10, AJ11, AJ20, AJ21, AJ22, AK8, AK9, AK10, AK11, AK20, AK21, AK22 **LFX1200:** AA22, AA23, AA24, AA25, AB23, AC24, T21, T22, T23, T24, T25, U21, U22, U23, U24, V21, V22, V23, W21, W22, W23, W24, Y22, Y23, Y24, AA16, AA17, AA18, AA19, AA21, AB16, AB17, AB18, AB19, AB20, AB21, AB22, AC16, AC17, AC18, AC19, AC20, AC21, AC22, AC23, AD16, AD17, AD19, AD20, AD22, AD23, AD24, AE22, AE25, AF25, AF26, AA10, AA12, AA13, AA14, AA15, AB10, AB11, AB12, AB13, AB14, AB15, AB9, AC10, AC11, AC12, AC13, AC14, AC15, AC8, AC9, AD11, AD12, AD14, AD15, AD7, AD8, AD9, AE6, AE9, AF5, AF6, H24, J23, K22, K23, K24, K25, L22, L23, L24, M21, M22, M23, M24, N21, N22, N23, P21, P22, P23, P24, R21, R22, R23, R24, R25, AA6, AA7, AA8, AA9, AB8, AC7, T10, T6, T7, T8, T9, U10, U7, U8, U9, V10, V8, V9, W10, W7, W8, W9, Y7, Y8, Y9, H5, H6, H7, J8, K6, K7, K8, K9, L7, L8, L9, M10, M7, M8, M9, N10, N8, N9, P10, P7, P8, P9, R10, R8, R9, E25, E26, F22, F25, G16, G17, G19, G20, G22, G23, G24, H16, H17, H18, H19, H20, H21, H22, H23, J16, J17, J18, J19, J20, J21, J22, K16, K17, K18, K19, K21, E5, E6, F6, F9, G11, G12, G14, G15, G7, G8, G9, H10, H11, H12, H13, H14, H15, H8, H9, J10, J11, J12, J13, J14, J15, J9, K10, K12, K13, K14, K15

1. All grounds must be electrically connected at the board level.
2. NC pins should not be connected to any active signals, V_{CC} or GND.
3. Balls for GND, V_{CC} and V_{CCOx} are connected within the substrate to their respective common signals. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

ispXPGA Logic Signal Connections: 256-Ball fpBGA (Cont.)

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]
-	GND (Bank 1)	-	-	-	-	-
L3	BK1_IO7	SS_CLKIN0N	16N	BK1_IO7	SS_CLKIN0N	14N
K2	BK1_IO8	-	17P	BK1_IO8	-	15P
-	-	-	-	GND (Bank 1)	-	-
L2	BK1_IO9	-	17N	BK1_IO9	-	15N
M1	BK1_IO10	HSI1A_SOUTP	18P/HSI1	BK1_IO10	-	16P
N1	BK1_IO11	HSI1A_SOUTN	18N/HSI1	BK1_IO11	-	16N
M3	BK1_IO12	PLL_RST2	19P/HSI1	BK1_IO12	PLL_RST2	17P
M4	BK1_IO13	PLL_RST3	19N/HSI1	BK1_IO13	PLL_RST3	17N
-	GND (Bank 1)	-	-	-	-	-
M2	BK1_IO16[1]	VREF1	-	BK1_IO14[1]	VREF1	-
P1	BK1_IO18	HSI1B_SOUTP	22P/HSI1	BK1_IO16	-	19P
-	-	-	-	GND (Bank 1)	-	-
R1	BK1_IO19	HSI1B_SOUTN	22N/HSI1	BK1_IO17	-	19N
N3	BK1_IO20[1]	-	-	BK1_IO18[1]	-	-
N2	BK1_IO22	HSI1B_SINP	24P/HSI1	BK1_IO20	-	21P
-	GND (Bank 1)	-	-	-	-	-
P2	BK1_IO23	HSI1B_SINN	24N/HSI1	BK1_IO21	-	21N
P4	TCK	-	-	TCK	-	-
T2	TMS	-	-	TMS	-	-
T3	TOE	-	-	TOE	-	-
R3	BK2_IO0	-	26P	BK2_IO0	-	22P
R4	BK2_IO1	-	26N	BK2_IO1	-	22N
N5	BK2_IO2	-	27P	BK2_IO2	-	23P
-	GND (Bank 2)	-	-	-	-	-
P5	BK2_IO3	-	27N	BK2_IO3	-	23N
-	-	-	-	GND (Bank 2)	-	-
T4	BK2_IO6	-	29P	BK2_IO6	-	25P
T5	BK2_IO7	-	29N	BK2_IO7	-	25N
N6	BK2_IO8	-	30P	BK2_IO8	-	26P
P6	BK2_IO9	VREF2	30N	BK2_IO9	VREF2	26N
R5	BK2_IO10	-	31P	BK2_IO10	-	27P
-	GND (Bank 2)	-	-	-	-	-
R6	BK2_IO11	-	31N	BK2_IO11	-	27N
N7	BK2_IO12	-	32P	BK2_IO12	-	28P
-	-	-	-	GND (Bank 2)	-	-
P7	BK2_IO13	-	32N	BK2_IO13	-	28N
T6	BK2_IO14	-	33P	BK2_IO14	-	29P
T7	BK2_IO15	-	33N	BK2_IO15	-	29N
M8	BK2_IO16	-	34P	BK2_IO16	-	30P
M9	BK2_IO17	-	34N	BK2_IO17	-	30N
R7	BK2_IO18	-	35P	BK2_IO18	-	31P

ispXPGA Logic Signal Connections: 256-Ball fpBGA (Cont.)

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]
C8	BK7_IO1	-	91N	BK7_IO1	-	77N
B8	BK7_IO2	-	92P	BK7_IO2	-	78P
B7	BK7_IO3	-	92N	BK7_IO3	-	78N
A9	BK7_IO6	-	94P	BK7_IO4	-	79P
-	GND (Bank 7)	-	-	-	-	-
A8	BK7_IO7	-	94N	BK7_IO5	-	79N
C7	BK7_IO10	-	96P	BK7_IO6	-	80P
D7	BK7_IO11	-	96N	BK7_IO7	-	80N
D6	BK7_IO12	-	97P	BK7_IO8	-	81P
-	-	-	-	GND (Bank 7)	-	-
C6	BK7_IO13	-	97N	BK7_IO9	-	81N
B6	BK7_IO14	-	98P	BK7_IO10	-	82P
-	GND (Bank 7)	-	-	-	-	-
B5	BK7_IO15	-	98N	BK7_IO11	-	82N
A7	BK7_IO16	VREF7	99P	BK7_IO12	VREF7	83P
A6	BK7_IO17	-	99N	BK7_IO13	-	83N
D5	BK7_IO18	-	100P	BK7_IO14	-	84P
C5	BK7_IO19	-	100N	BK7_IO15	-	84N
A5	BK7_IO20	-	101P	BK7_IO16	-	85P
-	-	-	-	GND (Bank 7)	-	-
A4	BK7_IO21	-	101N	BK7_IO17	-	85N
B4	BK7_IO22	-	102P	BK7_IO18	-	86P
-	GND (Bank 7)	-	-	-	-	-
B3	BK7_IO23	-	102N	BK7_IO19	-	86N
A3	TDO	-	-	TDO	-	-
A2	VCCJ	-	-	VCCJ	-	-
C4	TDI	-	-	TDI	-	-

1. Not available for differential pairs.
2. If a sysHSI Block is used, the indicated sysHSI reserved pins are unavailable for general purpose I/O use.

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved[1]
Y5	BK6_IO61	-	216N
-	GND (Bank 6)	-	-
-	GND (Bank 7)	-	-
W3	BK7_IO0	-	217P
W1	BK7_IO1	-	217N
W2	BK7_IO2	-	218P
-	GND (Bank 7)	-	-
W4	BK7_IO3	-	218N
V1	BK7_IO4	-	219P
V2	BK7_IO5	-	219N
V3	BK7_IO6	-	220P
V4	BK7_IO7	-	220N
W5	BK7_IO8	-	221P
U1	BK7_IO9	-	221N
U2	BK7_IO10	-	222P
-	GND (Bank 7)	-	-
U3	BK7_IO11	-	222N
U4	BK7_IO12	-	223P
T1	BK7_IO13	-	223N
T2	BK7_IO14	-	224P
T3	BK7_IO15	-	224N
R1	BK7_IO16	-	225P
R2	BK7_IO17	-	225N
T4	BK7_IO18	-	226P
-	GND (Bank 7)	-	-
P1	BK7_IO19	-	226N
P2	BK7_IO20	-	227P
P3	BK7_IO21	-	227N
R4	BK7_IO22	-	228P
T5	BK7_IO23	-	228N
M1	BK7_IO24	-	229P
M2	BK7_IO25	-	229N
N3	BK7_IO26	-	230P
-	GND (Bank 7)	-	-
P4	BK7_IO27	-	230N
L1	BK7_IO28	-	231P
M3	BK7_IO29	-	231N
L2	BK7_IO30	-	232P
N4	BK7_IO31	-	232N
K1	BK7_IO32	-	233P
K2	BK7_IO33	-	233N
P5	BK7_IO34	-	234P
-	GND (Bank 7)	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
L2	BK0_IO35	HSI1B_SINN	17N/HSI1	BK0_IO15	HSI0B_SINN	7N/HSI0
L6	BK0_IO36	-	18P/HSI1	BK0_IO16	-	8P/HSI0
L5	BK0_IO37	-	18N/HSI1	BK0_IO17	-	8N/HSI0
M1	BK0_IO38	HSI2A_SOUTP	19P/HSI1	BK0_IO18	HSI1A_SOUTP	9P/HSI1
-	-	-	-	GND (Bank 0)	-	-
M2	BK0_IO39	HSI2A_SOUTN	19N/HSI1	BK0_IO19	HSI1A_SOUTN	9N/HSI1
L3	BK0_IO40	-	20P/HSI1	BK0_IO20	-	10P/HSI1
L4	BK0_IO41	-	20N/HSI1	BK0_IO21	-	10N/HSI1
M6	BK0_IO42	HSI2A_SINP	21P/HSI2	BK0_IO22	HSI1A_SINP	11P/HSI1
-	GND (Bank 0)	-	-	-	-	-
M5	BK0_IO43	HSI2A_SINN	21N/HSI2	BK0_IO23	HSI1A_SINN	11N/HSI1
M4	BK0_IO44	-	22P/HSI2	BK0_IO24	-	12P/HSI1
M3	BK0_IO45	-	22N/HSI2	BK0_IO25	-	12N/HSI1
N1	BK0_IO46	HSI2B_SOUTP	23P/HSI2	BK0_IO26	HSI1B_SOUTP	13P/HSI1
-	-	-	-	GND (Bank 0)	-	-
N2	BK0_IO47	HSI2B_SOUTN	23N/HSI2	BK0_IO27	HSI1B_SOUTN	13N/HSI1
N7	BK0_IO48	-	24P/HSI2	BK0_IO28	-	14P/HSI1
N6	BK0_IO49	-	24N/HSI2	BK0_IO29	-	14N/HSI1
P1	BK0_IO50	HSI2B_SINP	25P/HSI2	BK0_IO30	HSI1B_SINP	15P/HSI1
-	GND (Bank 0)	-	-	-	-	-
P2	BK0_IO51	HSI2B_SINN	25N/HSI2	BK0_IO31	HSI1B_SINN	15N/HSI1
N3	BK0_IO52	-	26P/HSI2	BK0_IO32	-	16P/HSI1
N4	BK0_IO53	-	26N/HSI2	BK0_IO33	-	16N/HSI1
P6	BK0_IO54	PLL_RST0	27P/HSI2	BK0_IO38	PLL_RST0	19P
P5	BK0_IO55	PLL_RST1	27N/HSI2	BK0_IO35	PLL_RST1	17N
P3	BK0_IO56	-	28P/HSI2	BK0_IO36	-	18P
P4	BK0_IO57	-	28N/HSI2	BK0_IO39	-	19N
R7	BK0_IO58	PLL_FBK0	29P	BK0_IO34	PLL_FBK0	17P
-	GND (Bank 0)	-	-	GND (Bank 0)	-	-
R6	BK0_IO59	PLL_FBK1	29N	BK0_IO37	PLL_FBK1	18N
R1	BK0_IO60	CLK_OUT0	30P	BK0_IO40	CLK_OUT0	20P
-	-	-	-	GND (Bank 0)	-	-
R2	BK0_IO61	CLK_OUT1	30N	BK0_IO41	CLK_OUT1	20N
-	GND (Bank 0)	-	-	-	-	-
R3	GCLK0	-	LVDS Pair0P	GCLK0	-	LVDS Pair0P
R4	GCLK1	-	LVDS Pair0N	GCLK1	-	LVDS Pair0N
R5	VCCP0	-	-	VCCP0	-	-
T3	GNDP0	-	-	GNDP0	-	-
T4	GCLK2	-	LVDS Pair1P	GCLK2	-	LVDS Pair1P
T5	GCLK3	-	LVDS Pair1N	GCLK3	-	LVDS Pair1N
-	GND (Bank 1)	-	-	-	-	-
T2	BK1_IO0	CLK_OUT2	31P	BK1_IO0	CLK_OUT2	21P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
-	-	-	-	GND (Bank 1)	-	-
T1	BK1_IO1	CLK_OUT3	31N	BK1_IO1	CLK_OUT3	21N
U2	BK1_IO2	SS_CLKOUT0P	32P	BK1_IO2	SS_CLKOUT0P	22P
-	GND (Bank 1)	-	-	-	-	-
U1	BK1_IO3	SS_CLKOUT0N	32N	BK1_IO3	SS_CLKOUT0N	22N
U3	BK1_IO4	PLL_FBK2	33P	BK1_IO4	PLL_FBK2	23P
U4	BK1_IO5	PLL_FBK3	33N	BK1_IO5	PLL_FBK3	23N
V1	BK1_IO6	SS_CLKIN0P	34P	BK1_IO10	SS_CLKIN0P	26P
V2	BK1_IO7	SS_CLKIN0N	34N	BK1_IO11	SS_CLKIN0N	26N
U5	BK1_IO8	-	35P	BK1_IO12	-	27P
U6	BK1_IO9	-	35N	BK1_IO13	-	27N
V4	BK1_IO10	-	36P	BK1_IO6	-	24P
-	GND (Bank 1)	-	-	GND (Bank 1)	-	-
V3	BK1_IO11	-	36N	BK1_IO7	-	24N
V6	BK1_IO12	PLL_RST2	37P	BK1_IO20	PLL_RST2	31P
V7	BK1_IO13	PLL_RST3	37N	BK1_IO21	PLL_RST3	31N
W1	BK1_IO14	-	38P	BK1_IO8	-	25P
W2	BK1_IO15	-	38N	BK1_IO9	-	25N
W3	BK1_IO16	-	39P	BK1_IO14	-	28P
-	-	-	-	GND (Bank 1)	-	-
W4	BK1_IO17	-	39N	BK1_IO15	-	28N
W5	BK1_IO18	-	40P	BK1_IO16	-	29P
-	GND (Bank 1)	-	-	-	-	-
W6	BK1_IO19	-	40N	BK1_IO17	-	29N
Y6	BK1_IO20	-	41P/HSI3	NC	-	-
Y5	BK1_IO21	-	41N/HSI3	NC	-	-
Y4	BK1_IO22	-	42P/HSI3	NC	-	-
Y3	BK1_IO23	-	42N/HSI3	NC	-	-
AA5	BK1_IO24	-	43P/HSI3	NC	-	-
AA4	BK1_IO25	-	43N/HSI3	NC	-	-
Y2	BK1_IO26	HSI3A_SOUTP	44P/HSI3	BK1_IO18	HSI2A_SOUTP	30P
-	GND (Bank 1)	-	-	-	-	-
Y1	BK1_IO27	HSI3A_SOUTN	44N/HSI3	BK1_IO19	HSI2A_SOUTN	30N
AB7	BK1_IO28	-	45P/HSI3	NC	-	-
AB6	BK1_IO29	-	45N/HSI3	NC	-	-
AA2	BK1_IO30	HSI3A_SINP	46P/HSI3	BK1_IO22	HSI2A_SINP	32P
-	-	-	-	GND (Bank 1)	-	-
AA1	BK1_IO31	HSI3A_SINN	46N/HSI3	BK1_IO23	HSI2A_SINN	32N
AB5	BK1_IO32	-	47P/HSI3	NC	-	-
AB4	BK1_IO33	-	47N/HSI3	NC	-	-
AB2	BK1_IO34	HSI3B_SOUTP	48P/HSI3	NC	-	-
-	GND (Bank 1)	-	-	-	-	-

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
U27	BK4_IO57	PLL_FBK5	152N	BK4_IO37	PLL_FBK5	102N
U29	BK4_IO58	SS_CLKOUT1P	153P	BK4_IO38	SS_CLKOUT1P	103P
-	GND (Bank 4)	--	-	-	-	-
U30	BK4_IO59	SS_CLKOUT1N	153N	BK4_IO39	SS_CLKOUT1N	103N
T30	BK4_IO60	CLK_OUT4	154P	BK4_IO40	CLK_OUT4	104P
-	-	-	-	GND (Bank 4)	-	-
T29	BK4_IO61	CLK_OUT5	154N	BK4_IO41	CLK_OUT5	104N
-	GND (Bank 4)	-	-	-	-	-
T28	GCLK4	-	LVDS Pair2P	GCLK4	-	LVDS Pair2P
T27	GCLK5	-	LVDS Pair2N	GCLK5	-	LVDS Pair2N
T26	VCCP1	-	-	VCCP1	-	-
R28	GNDP1	-	-	GNDP1	-	-
R27	GCLK6	-	LVDS Pair3P	GCLK6	-	LVDS Pair3P
R26	GCLK7	-	LVDS Pair3N	GCLK7	-	LVDS Pair3N
-	GND (Bank 5)	-	-	-	-	-
R29	BK5_IO0	CLK_OUT6	155P	BK5_IO0	CLK_OUT6	105P
-	-	-	-	GND (Bank 5)	-	-
R30	BK5_IO1	CLK_OUT7	155N	BK5_IO1	CLK_OUT7	105N
P30	BK5_IO2	PLL_FBK6	156P	BK5_IO4	PLL_FBK6	107P
-	GND (Bank 5)	-	-	GND (Bank 5)	-	-
P29	BK5_IO3	PLL_FBK7	156N	BK5_IO7	PLL_FBK7	108N
P27	BK5_IO4	-	157P/HSI7	BK5_IO2	-	106P
P28	BK5_IO5	-	157N/HSI7	BK5_IO5	-	107N
P26	BK5_IO6	PLL_RST6	158P/HSI7	BK5_IO6	PLL_RST6	108P
P25	BK5_IO7	PLL_RST7	158N/HSI7	BK5_IO3	PLL_RST7	106N
N27	BK5_IO8	-	159P/HSI7	BK5_IO8	-	109P/HSI4
N28	BK5_IO9	-	159N/HSI7	BK5_IO9	-	109N/HSI4
N29	BK5_IO10	HSI7A_SINP	160P/HSI7	BK5_IO10	HSI4A_SINP	110P/HSI4
-	GND (Bank 5)	-	-	-	-	-
N30	BK5_IO11	HSI7A_SINN	160N/HSI7	BK5_IO11	HSI4A_SINN	110N/HSI4
N25	BK5_IO12	-	161P/HSI7	BK5_IO12	-	111P/HSI4
N24	BK5_IO13	-	161N/HSI7	BK5_IO13	-	111N/HSI4
M29	BK5_IO14	HSI7A_SOUTP	162P/HSI7	BK5_IO14	HSI4A_SOUTP	112P/HSI4
-	-	-	-	GND (Bank 5)	-	-
M30	BK5_IO15	HSI7A_SOUTN	162N/HSI7	BK5_IO15	HSI4A_SOUTN	112N/HSI4
M28	BK5_IO16	-	163P/HSI7	BK5_IO16	-	113P/HSI4
M27	BK5_IO17	-	163N/HSI7	BK5_IO17	-	113N/HSI4
L30	BK5_IO18	HSI7B_SINP	164P/HSI7	BK5_IO18	HSI4B_SINP	114P/HSI4
-	GND (Bank 5)	-	-	-	-	-
L29	BK5_IO19	HSI7B_SINN	164N/HSI7	BK5_IO19	HSI4B_SINN	114N/HSI4
M26	BK5_IO20	-	165P/HSI8	BK5_IO20	-	115P/HSI4
M25	BK5_IO21	-	165N/HSI8	BK5_IO21	-	115N/HSI4

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
G25	BK5_IO57	-	183N	NC	-	-
F26	BK5_IO58	-	184P	NC	-	-
-	GND (Bank 5)	-	-	-	-	-
E28	BK5_IO59	-	184N	NC	-	-
E27	BK5_IO60	-	185P	BK5_IO40	-	125P
D28	BK5_IO61	-	185N	BK5_IO41	-	125N
C27	CFG0	-	-	CFG0	-	-
B28	DONE	-	-	DONE	-	-
A28	PROGRAMb	-	-	PROGRAMb	-	-
D26	BK6_IO0	INITb	186P	BK6_IO0	INITb	126P
C26	BK6_IO1	CCLK	186N	BK6_IO1	CCLK	126N
B27	BK6_IO2	-	187P	BK6_IO2	-	127P
-	GND (Bank 6)	-	-	GND (Bank 6)	-	-
A27	BK6_IO3	-	187N	BK6_IO3	-	127N
D25	BK6_IO4	CSb	188P	BK6_IO4	CSb	128P
C25	BK6_IO5	Read	188N	BK6_IO5	READ	128N
B26	BK6_IO6	-	189P	BK6_IO6	-	129P
A26	BK6_IO7	-	189N	BK6_IO7	-	129N
F24	BK6_IO8	-	190P	BK6_IO8	-	130P
E24	BK6_IO9	-	190N	BK6_IO9	-	130N
A25	BK6_IO10	-	191P	BK6_IO10	-	131P
-	GND (Bank 6)	-	-	GND (Bank 6)	-	-
B25	BK6_IO11	-	191N	BK6_IO11	-	131N
D24	BK6_IO12	VREF6	192P	BK6_IO21	VREF6	136N
C24	BK6_IO13	-	192N	BK6_IO20	-	136P
A24	BK6_IO14	-	193P	BK6_IO12	-	132P
B24	BK6_IO15	-	193N	BK6_IO13	-	132N
F23	BK6_IO16	-	194P	BK6_IO14	-	133P
E23	BK6_IO17	-	194N	BK6_IO15	-	133N
A23	BK6_IO18	-	195P	BK6_IO16	-	134P
-	GND (Bank 6)	-	-	-	-	-
B23	BK6_IO19	-	195N	BK6_IO17	-	134N
C23	BK6_IO20	-	196P	NC	-	-
D23	BK6_IO21	-	196N	NC	-	-
E22	BK6_IO22	-	197P	NC	-	-
D22	BK6_IO23	-	197N	NC	-	-
G21	BK6_IO24	-	198P	NC	-	-
F21	BK6_IO25	-	198N	NC	-	-
B22	BK6_IO26	-	199P	NC	-	-
-	GND (Bank 6)	-	-	-	-	-
A22	BK6_IO27	-	199N	NC	-	-
E21	BK6_IO28	-	200P	NC	-	-